PDS5100H

5A HIGH VOLTAGE SCHOTTKY BARRIER RECTIFIER

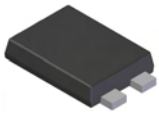
PowerDI®5

Features

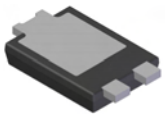
- Guard Ring Die Construction for Transient Protection
- High Maximum Junction Temperature
- Very Low Leakage Current
- Highly Stable Oxide Passivated Junction
- Low Forward Voltage Drop
- High Forward Surge Current Capability
- **Lead Free Finish, RoHS Compliant (Note 1)**
- **"Green" Molding Compound (No Br, Sb)**
- **Qualified to AEC-Q101 Standards for High Reliability**

Mechanical Data

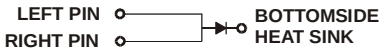
- Case: PowerDI®5
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish – Matte Tin annealed over Copper leadframe. Solderable per MIL-STD-202, Method 208 (e3)
- Polarity: See Diagram
- Weight: 0.096 grams (approximate)



Top View



Bottom View



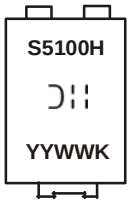
Note: Pins Left & Right must be electrically connected at the printed circuit board.

Ordering Information (Note 2)

Part Number	Case	Packaging
PDS5100H-13	PowerDI®5	5000/Tape & Reel

Notes: 2. For packaging details, go to our website at http://www.diodes.com.

Marking Information



S5100H = Product type marking code
YYWW = Date code marking
YY = Last two digits of year (ex: 04 for 2004)
WW = Week code (01 - 53)
K = Factory Designator

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Maximum Ratings @T_A = 25°C unless otherwise specified

Single phase, half wave, 60Hz, resistive or inductive load.
For capacitance load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWM} V_R	100	V
RMS Reverse Voltage	$V_{R(RMS)}$	71	V
Average Rectified Output Current (See also figure 5)	I_O	5	A
Non-Repetitive Peak Forward Surge Current 8.3ms Single half sine-wave Superimposed on Rated Load	I_{FSM}	250	A

Thermal Characteristics

Characteristic	Symbol	Typ	Max	Unit
Thermal Resistance Junction to Soldering Point	$R_{\theta JS}$	—	2.0	°C/W
Thermal Resistance Junction to Ambient Air (Note 3) T_A = 25°C	$R_{\theta JA}$	85	—	°C/W
Thermal Resistance Junction to Ambient Air (Note 4) T_A = 25°C	$R_{\theta JA}$	70	—	°C/W
Thermal Resistance Junction to Ambient Air (Note 5) T_A = 25°C	$R_{\theta JA}$	45	—	°C/W
Operating and Storage Temperature Range	T_J, T_{STG}	-65 to +175		°C

Electrical Characteristics @T_A = 25°C unless otherwise specified

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 6)	$V_{(BR)R}$	100	—	—	V	I_R = 3.5μA
Forward Voltage	V_F	— — — —	0.67 0.55 0.75 0.62	0.71 0.58 0.80 0.66	V	I_F = 5A, T_S = 25°C I_F = 5A, T_S = 125°C I_F = 10A, T_S = 25°C I_F = 10A, T_S = 125°C
Reverse Leakage Current (Note 6)	I_R	— —	0.3 0.5	3.5 4.5	μA mA	T_S = 25°C, V_R = 100V T_S = 125°C, V_R = 100V

Notes:
3. FR-4 PCB, 2 oz. Copper, minimum recommended pad layout per http://www.diodes.com.
4. Polymide PCB, 2 oz. Copper, minimum recommended pad layout per http://www.diodes.com.
5. Polymide PCB, 2 oz. Copper. Cathode pad dimensions 9.4mm x 7.2mm. Anode pad dimensions 2.7mm x 1.6mm.
6. Short duration pulse test used to minimize self-heating effect.

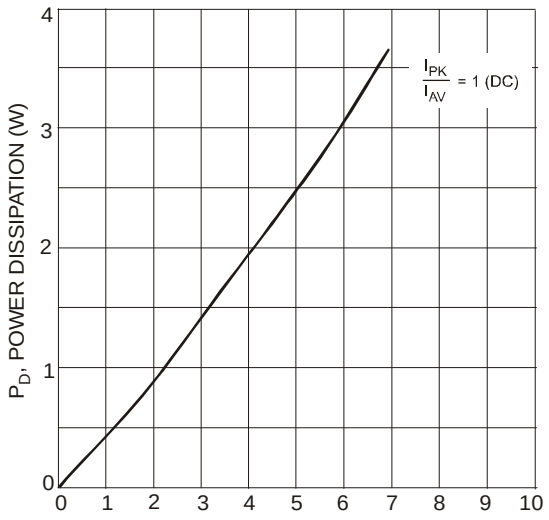


Fig. 1 Forward Power Dissipation

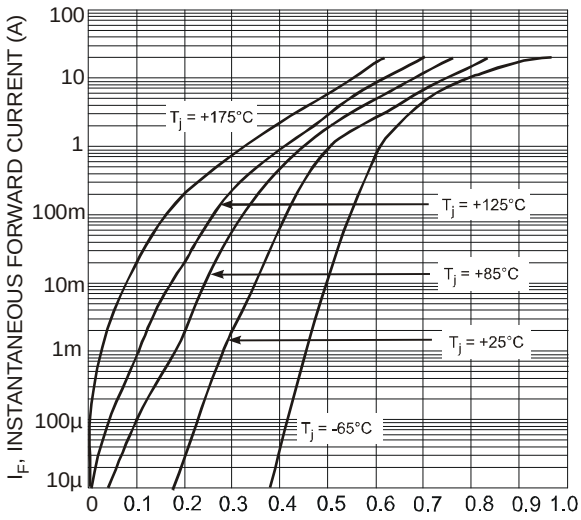


Fig. 2 Typical Forward Characteristics

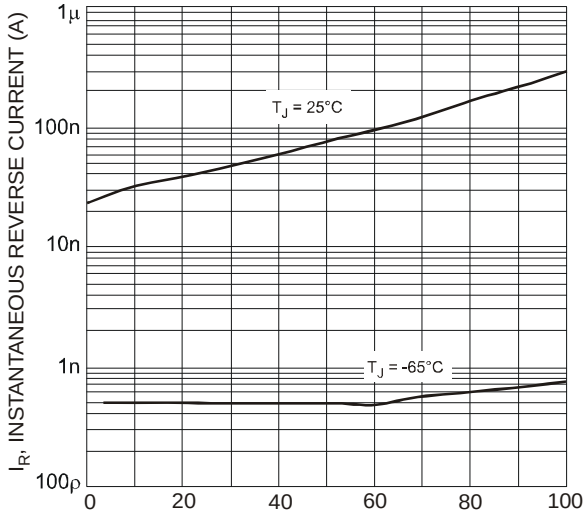


Fig. 3 Typical Reverse Characteristics

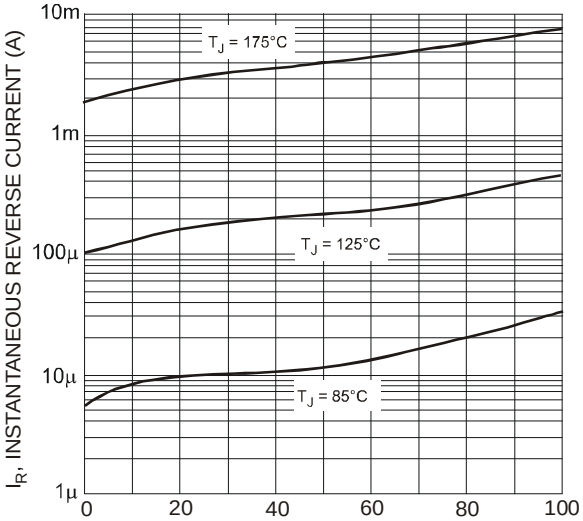


Fig. 4 Typical Reverse Characteristics

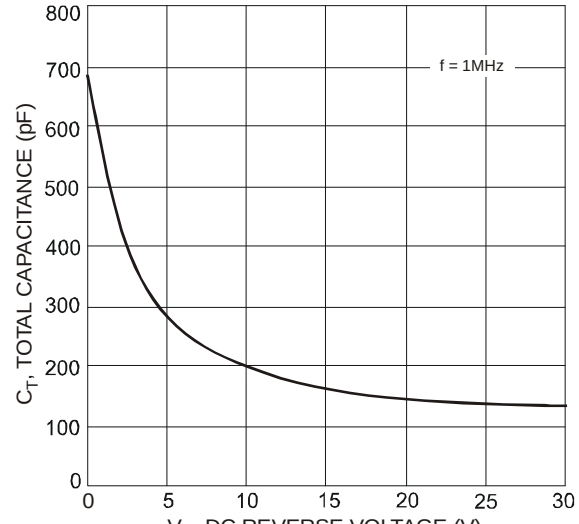


Fig. 5 Total Capacitance vs. Reverse Voltage

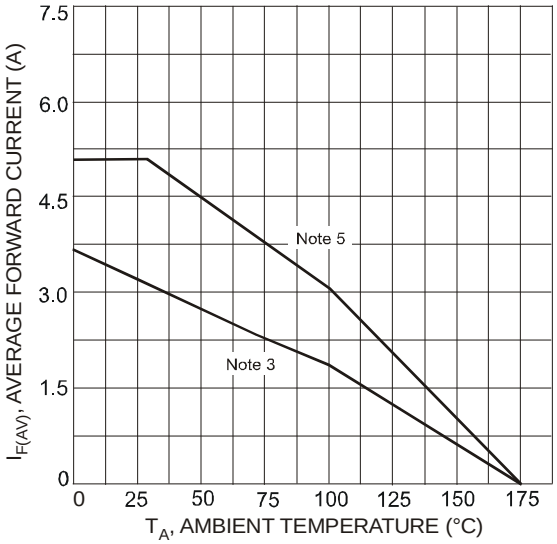


Fig. 6 Forward Current Derating Curve

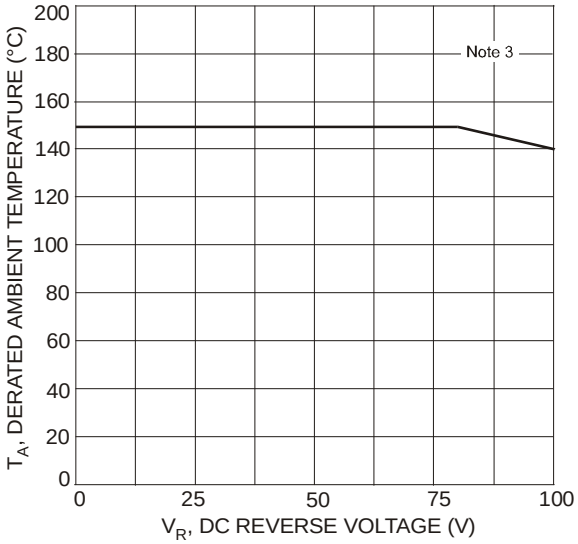
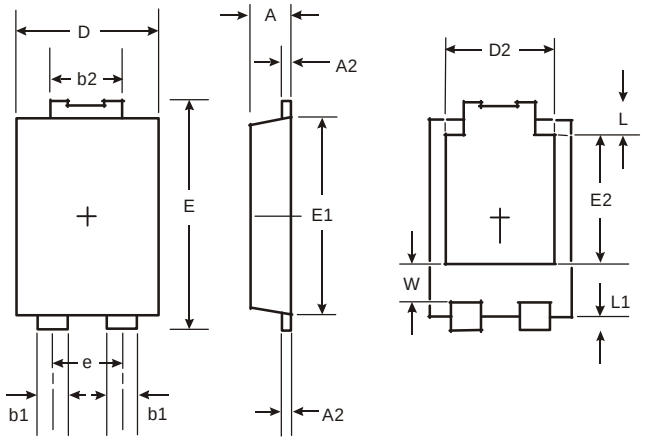


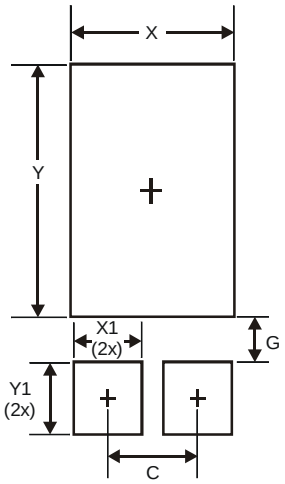
Fig. 7 Operating Temperature Derating

Package Outline Dimensions



PowerDI®5		
Dim	**Min**	**Max**
A	1.05	1.15
A2	0.33	0.43
b1	0.80	0.99
b2	1.70	1.88
D	3.90	4.05
D2	3.054 Typ	
E	6.40	6.60
e	1.84 Typ	
E1	5.30	5.45
E2	3.549 Typ	
L	0.75	0.95
L1	0.50	0.65
W	1.10	1.41
All Dimensions in mm		

Suggested Pad Layout



Dimensions	Value (in mm)
C	1.840
G	0.852
X	3.360
X1	1.390
Y	4.860
Y1	1.400

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